

INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10551305	
	Filing Date		2006-11-14	
	First Named Inventor	Nancy Dean		
	Art Unit	2823		
	Examiner Name	William D. Coleman		
	Attorney Docket Number	H0004275.84418 US2 - 4018		

U.S.PATENTS

Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
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Examiner Initial*	Cite No	Publication Number	Kind Code ¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1	20050011656	A1	2005-01-20	Maxwell Technologies, Inc.	
	2	20050012080	A1	2005-01-20	Quantum Leap Packaging, Inc.	
	3	20050012186	A1	2005-01-20	Quantum Leap Packaging, Inc.	
	4	20050016750	A1	2005-01-27	Quantum Leap Packaging, Inc.	
	5	20050029657	A1	2005-02-10	Broadcom Corporation	

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	6	20050041406	A1	2005-02-24	James Christopher Matayabas Jr., et al.	
	7	20050051893	A1	2005-03-10	Taiwan Semiconductor Manufacturing Co.	
	8	20050062143	A1	2005-03-24	LSI Logic Corporation	
	9	20050062154	A1	2005-03-24	International Business Machines Corporation	
	10	20050077000	A1	2005-04-14	Julian Norley, et al.	
	11	20050079304	A1	2005-04-14	Timothy Clovesko, et al.	
	12	20050079355	A1	2005-04-14	Timothy Clovesko, et al.	
	13	20050110140	A1	2005-05-26	Taiwan Semiconductor Manufacturing Co.	
	14	20050142317	A1	2005-06-30	Timothy Clovesko, et al.	
	15	20050183444	A1	2005-08-25	Mark Munch, et al.	
	16	20050189568	A1	2005-09-01	International Business Machines Corporation	

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17	20050189647	A1	2005-09-01	Chien-Min Sung	
18	20050241801	A1	2005-11-03	Jonathan E. Mitchell, et al.	
19	20050250252	A1	2005-11-10	Yuan Li	
20	20060001152	A1	2006-01-05	Phoenix Precision Technology Corporation	
21	20060019429	A1	2006-01-26	ChipPAC, Inc.	
22	20060021734	A1	2006-02-02	Shih-Ying Chang, et al.	
23	20060033203	A1	2006-02-16	HON HAI Precision Industry Co., Ltd.	
24	20060044749	A1	2006-03-02	Robert S. Pauley, et al.	
25	20060060963	A1	2006-03-23	Taiwan Semiconductor Manufacturing Company, Ltd.	
26	20060061965	A1	2006-03-23	Visteon Global Technologies, Inc.	
27	20060091532	A1	2006-05-04	Chien-Min Sung	

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	28	20060098413	A1	2006-05-11	Joseph P. Capp	
	29	20060109630	A1	2006-05-25	Evan George Colgan, et al.	
	30	20060113546	A1	2006-06-01	Chien-Min Sung	
	31	20060118947	A1	2006-06-08	Taiwan Semiconductor Manufacturing Co., Ltd.	
	32	20060120054	A1	2006-06-08	Endress & Hauser Gmbh & Co. KG	
	33	20060131711	A1	2006-06-22	Yoshihiko Ino	
	34	20060138622	A1	2006-06-29	Daoqiang Lu, et al	
	35	20060138643	A1	2006-06-29	Daoqiang Lu, et al	
	36	20060145316	A1	2006-07-06	Sang-uk Kim, et al.	
	37	20060145320	A1	2006-07-06	Pete D. Vogt	
	38	20060151873	A1	2006-07-13	Mark Fery, et al.	

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39	20060171123	A1	2006-08-03	Tyco Electronics Corporation	
40	20060182385	A1	2006-08-17	Samsung Electro-Mechanics Co., Ltd.	
41	20060185823	A1	2006-08-24	John G. Thayer, et al.	
42	20060191707	A1	2006-08-31	NGK Insulators, Ltd.	
43	20060214283	A1	2006-09-28	Sang-Uk Kim, et al.	
44	20060214295	A1	2006-09-28	Katsufumi Tanaka	
45	20060220226	A1	2006-10-05	Intel Corporation	
46	20070035012	A1	2007-02-15	Carl L. Deppisch, et al.	
47	20080096324	A1	2008-04-24	Daoqiang Lu, et al.	
48	20080174007	A1	2008-07-24	Intel Corporation	
49	20080185713	A1	2008-08-07	Intel Corporation	

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	50	20030056938	A1	2003-03-27	Kevin A. McCullough	
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FOREIGN PATENT DOCUMENTS

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